

Final Product Change Notification

Issue Date: 29-May-2020 Effective Date: 27-Aug-2020 Dear Emma Tempest,

Here's your personalized quality information concerning products Premier Farnell PLC purchased from NXP. For detailed information we invite you to <u>view this</u> notification online

This notice is NXP Company Proprietary.

202005014F01



Management Summary

In order to secure the customer delivery and fab capacity, enable TSMC10 to support NX20P0407 manufacturing as 2nd source.

Change Category			
[] Wafer Fab Process	[] Assembly [] Product Marking Process	[] Test Location	[] Design
[] Wafer Fab Materials	[] Assembly [] Mechanical Materials Specification	[]Test Process	[] Errata
[X] Wafer Fab Location	[] Assembly [] Location Packing/Shipping/Lab	[] Test	[] Electrical spec./Test coverage
[] Firmware	[] Other		
NX20P0407 FAB			

Description of Change

TO TSMC10)

EXPANSION (SSMC

NXP Semiconductors is announcing the introduction of Taiwan Semiconductor Manufacturing Company Fab 10 (TSMC10), Shanghai, China as a dual source wafer manufacturing location for the NX20P0407 (WLCSP12).

Reason for Change

The Fab manufacturing site capacity expansion to TSMC10 will improve NXP's ability to meet increasing customer demand and still maintain supply from the original Fab (SSMC).

Identification of Affected Products

Top side marking

The last 5 digits of the Mask ID marking will change from ZYWW to NYWW. 'Z' for SSMC; 'N' for TSMC10

Product Availability

Sample Information Samples are available upon request

Production

Planned first shipment 29-May-2020

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Fab Expansion. No Depletion of Inventory required.

Additional information

Affected products and sales history information: see attached file

Self qualification: view online

Additional documents: view online

Timing and Logistics

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by 28-Jun-2020. Contact and Support

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For all inquiries regarding the ePCN tool application or access issues, please <u>contact NXP "Global Quality</u> <u>Support Team"</u>.

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly: Name Wenfeng Zhao

Position BL Quality Engineer

e-mail address wenfeng.zhao@nxp.com

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Customer Focus, Passion to Win.

NXP Quality Management Team.

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